

## Features & Benefits

- Thermal Conductivity of 4.0 W/m-K
- Highly Conformable with low hardness
- Electrically Isolating
- Low Interfacial Resistance

## Applications

- Automotive Electronics (HEV, NEV, Batteries)
- PCBA to heatsink
- Discrete components to heat spreader
- Laser/LED module heat dissipation

## Introduction

**TCLAD TCFP** series is a thermally conductive silicone-based gap filling pad type material that is an ideal thermal interface material specifically designed for heatsink attachment to a heat source like PCB, MCPCB, or component package. The purpose of the material is to fill a gap or space and minimize thermal resistance between the heat source and the heat sink or heat spreader. TCFP series has excellent thermal conductivity cushioning and gap-filling properties.

**Typical properties** of gap filling pad type materials have the following characteristics: thermal conductivity, hardness, volume resistivity, etc. It is typically offered in sheets or custom part size and shapes.

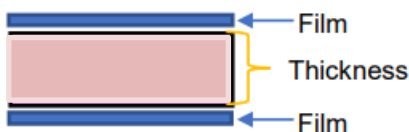
**How to use:** Remove the liner on one side and place the pad onto the first surface, PCB, component or heatsink. Remove the second liner and apply the mating surface as needed in the application.

**Useable life and storage:** TCFP products perform best if stored in a cool and dry / non-humid environment, especially where it is not exposed to any sunlight. Typical shelf life is up to 12 months when properly stored.

**Package Information:** Typical package can be individual, or bulk packed or can be in trays or tape and reel.

**Precautions:** Please review the technical data sheet of the material before use of the product in terms of the material characteristics to fit one's application. All values stated here are typical values.

We provide custom solutions for your applications. For further inquiries, please contact your local sales agent or directly to TCLAD sales in your region.



Item	Condition	Unit	Value	Method
<b>General</b>				
Color	Visual	-	Pink	-
Continuous Use Temp	-	°C	-50 ~ 200	-
Thickness	Mitutoyo	mm	0.5 ~ 10	-
Density	25°C	g/cc	3.2	ASTM D792
Hardness	Shore	00	45	ASTM D2240
<b>Electrical</b>				
Dielectric Constant	1 GHz	-	7.0	ASTM D150
Breakdown Voltage	AC	KV/mm	>10	ASTM D149
Volume Resistivity	-	Ω cm	>1×10 <sup>13</sup>	ASTM D257
<b>Thermal</b>				
Thermal Conductivity	-	W/m-K	4.0	ASTM D5470
<b>Durability</b>				
RoHS	-	-	Compliant	
Flame Rating	Vertical Burn Test	-	V-0	UL94

### Application Tips:

- **Clean Surfaces:** Ensure that surfaces are thoroughly cleaned and free from debris before applying thermal pads. This will help achieve optimal thermal contact and performance.
- **Select the Right Thickness:** Choose the appropriate pad thickness based on the gap to be filled and the desired level of compression for optimal thermal management.
- **Apply Light Pressure:** Apply light, even pressure when placing the pad to ensure proper adhesion and maximize thermal efficiency between the components.
- **Choose Based on Thermal Conductivity:** Select the thermal pad with the appropriate conductivity for your specific application to ensure effective heat transfer.
- **Proper Storage:** Store pads in a cool, dry environment to maintain their effectiveness and prevent degradation over time.

## TCLAD

US [Sales.us@tclad.com](mailto:Sales.us@tclad.com)  
 APAC [Sales.asia@tclad.com](mailto:Sales.asia@tclad.com)  
 Europe [Sales.eu@tclad.com](mailto:Sales.eu@tclad.com)  
[www.tclad.com](http://www.tclad.com)



All statements, technical information and recommendations herein are based on tests we believe to be reliable, and THE FOLLOWING IS MADE IN LIEU OF ALL WARRANTIES OR IMPLIED, INCLUDING THE IMPLIED WARRANTIES OF MARKET ABILITY AND FITNESS FOR PURPOSE. Sellers' and manufacturers' only obligation shall be to replace such quantity of the product proved to be defective. Before use, user shall determine the suitability of the product for its intended use, and the user assumes all risk and liability whatsoever in connection therewith. NEITHER SELLER NOR MANUFACTURER SHALL BE LIABLE EITHER IN TORT OR IN CONTRACT FOR ANY LOSS OR DAMAGE DIRECT, INCIDENTAL, OR CONSEQUENTIAL, INCLUDING LOSS OF PROFITS OR REVENUE ARISING OUT OF THE USE OR THE INABILITY TO USE THE PRODUCT. No statement, purchase order or recommendation by seller or purchaser not contained herein shall have any force or effect unless in an agreement signed by the officers of the seller and manufacturer. All marks used above are trademarks and/or registered trademarks of TCLAD Inc and its affiliates in the U.S., Germany and elsewhere. © 2021 TCLAD Inc. All rights reserved. US



Rev 2025 D111-001